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Dated: November 18, 2002 Signature: _____

(Kimberly V. Perry)

7 / Response
w/ drawings
12/6/02
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Docket No.: TESSERA 3.0-255
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Warner et al.

Application No.: 09/811,803

Group Art Unit: 2823

Filed: March 19, 2001

Examiner: Fernando Toledo

For: METHODS OF MAKING
MICROELECTRONIC
ASSEMBLIES USING COMPRESSED
RESILIENT LAYER

Commissioner for Patents
Washington, DC 20231

AMENDMENT

Dear Sir:

In response to the Official Action mailed
July 17, 2002, Applicants submit the following remarks.

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